507047214 12/27/2021

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
JUN CHEN	12/27/2021

RECEIVING PARTY DATA

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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	29821077

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NAME OF SUBMITTER:	CHIH KUEI HU
SIGNATURE:	/Chih Kuei Hu/
DATE SIGNED: 12/27/2021	
	This document serves as an Oath/Declaration (37 CFR 1.63).

Total Attachments: 2 source=CDA#page1.tif source=CDA#page2.tif

> **PATENT** REEL: 058484 FRAME: 0807

507047214

Combined Declaration and Assignment for Utility or Design Patent Application

DECLARATION

Intle or Invention	Vinyl Records Lab	pel Protector Silicone Sleeve
As the belov	w named inventor, I	hereby declare that:
This declara	tion is directed to:	⊠The attached application, or
		☐ United States application
		filed on

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

ASSIGNMENT

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged by the undersigned inventor(s) (hereinafter ASSIGNOR). The undersigned ASSIGNOR hereby:

- 1. Sell, assign and transfer to <u>Shenzhen Taylor Bonwe Electronic Commerce Co., Ltd.</u>, an institute in the People's Republic of China having place at <u>527-528</u>, <u>Chang'an Building</u>, <u>No.56</u>, <u>Second Industrial Zone</u>, <u>Houting Community</u>, <u>Shajing Street</u>, <u>Bao'an District</u>, <u>Shenzhen Guangdong</u> (hereinafter ASSIGNEE), the entire right, title and interest in any and all improvements and inventions disclosed in applications based upon, and patents (including foreign patents and the right to claim priority) granted upon, the above-referenced application.
- 2. Authorize and request the Commissioner of Patents to issue any and all Letters Patents resulting from said application or any division, continuation, substitute, renewal, reexamination or reissue thereof to the ASSIGNEE.
- 3. Agree to execute all papers and documents and, entirely at the ASSIGNEE's expense, perform any acts which are reasonably necessary in connection with the prosecution of said application, as well as any derivative applications thereof, foreign applications based thereon, and/or the enforcement of patents resulting from such applications.

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- 4. Agree that the terms, covenants and conditions of this assignment shall inure to the benefit of the ASSIGNEE, its successors, assigns and other legal representative, and shall be binding upon the inventor, as well as the inventor's heirs, legal representatives and assigns.
- Warrant and represent that we have not entered, and will not enter into any assignment, contract, or understanding that conflicts with this assignment.
- 6. Authorize and request our representatives to insert the application number and any other identification which may be necessary or desirable for purposes of recordation of this assignment.

Hereby executed by the undersigned on the date opposite the undersigned name:

Legal name of inventor:	Jun CHEN		\$ N
Inventor's signature:	· 1.6	Date:	2021.17.21